

IN THE CLAIMS:

In line 1, delete "Patent Claims" and insert:

C L A I M S

Please add new claims 19 and 20 and amend claims 1-18 to read as follows:

1. (Currently Amended) Blister package arrangement with a blister package ~~(1)~~ and a conductor carrier strip ~~(10)~~ connected to it, wherein openings ~~(4)~~ in the conductor carrier strip ~~(10)~~ are directed toward pockets ~~(3)~~ of the blister package ~~(1)~~, and wherein, upon removal of a tablet ~~(2)~~ from a pocket ~~(3)~~, a sealing film ~~(13)~~ of the blister package ~~(1)~~ sealing the pocket ~~(3)~~ ~~may~~ must be separated, and the tablet ~~(2)~~ is removable through an opening ~~(4)~~ assigned to it, ~~characterized in that~~ the improvement wherein the openings ~~(4)~~ are formed by stamped lines ~~(41)~~ positioned within the conductor carrier strip ~~(10)~~ that surround each of the pockets ~~(3)~~ in a ring shape, and that are interrupted by at least two spars ~~(42, 43)~~ by means of which a covering, ~~(30)~~ separated by the stamped line ~~(41)~~ out of the conductor carrier strip ~~(10)~~ and covering the

pocket, ~~(3)~~ is connected with the conductor carrier strip ~~(10)~~; ~~that~~ wherein the spars ~~(42, 43)~~ are so distributed about the ~~circumference~~ periphery of the stamped line ~~(41)~~ that, when a tablet ~~(2)~~ is pressed out from a pocket ~~(3)~~, at least one spar ~~(42)~~ is ~~broken~~ severed; and ~~that~~ wherein the conductor carrier strip ~~(10)~~ includes individual conductors ~~(52)~~ each of which extends from an individual ~~connection~~ point ~~(51)~~ connecting pad over at least the one spar ~~(42)~~ that is ~~broken~~ severed upon tablet removal.

2. (Currently Amended) Blister package arrangement as in Claim 1, ~~characterized in that~~ wherein the individual ~~connection points~~ ~~(52)~~ connecting pads and ~~the~~ a common connection pad ~~point~~ ~~(54)~~ are components of an interface ~~(5)~~ that, when the blister package arrangement is inserted into a receiver device ~~(40)~~, only one physical polarity is possible, and is connected electrically with an electronic unit positioned in the receiver device ~~(40)~~ to ~~determine~~ interruption detect the severance of the individual conductors ~~(52)~~.

3. (Currently Amended) Blister package arrangement as in Claim 2, ~~characterized in that~~ wherein the individual

~~connection points (51)~~ connecting pads and the a common connection pad point ~~(54)~~ are components of an interface, which upon insertion of the blister package arrangement in a the receiver device, effect a defined position orientation and are electrically connected with an electronic unit in the receiver device to detect the ~~interruption~~ severance of the individual conductors.

4. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 3, characterized in that~~ Claim 1, wherein the stamped lines ~~(41)~~ are have a shape selected from the group consisting of rectangular, circular, or and oval ~~in shape.~~

5. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 4, characterized in that~~ Claim 1, wherein the spars ~~(43)~~ are positioned diametrically opposite each other about the circumference of the stamped line ~~(41)~~, and ~~that~~ wherein the individual conductor ~~(52)~~ associated therewith extends over both spars ~~(42, 43).~~

6. (Currently Amended) Blister package arrangement as in Claim 5, ~~characterized in that~~ wherein the two spars ~~(42,~~

43) each lie along the direction of the longer extension of the stamped line (41).

7. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 6, characterized in that~~ Claim 6, wherein the individual conductor (52) extends over the first and the additional spars (42, 43).

8. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 4, characterized in that~~ Claim 1, wherein the individual conductor (52) extends only over one of the spars (42 or 43) from the conductor carrier strip (10) to the covering (30), and from the covering (30) back to the conductor carrier strip (10) as a loop, whereby the conductor-bearing spar (42 or 43) is positively broken severed upon tablet removal.

9. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 8, characterized in that~~ Claim 1, wherein the conductor carrier strip (10) includes the individual conductors (52) on the side facing away from the blister package (1), and is attached, ~~preferably adhered,~~ to the side facing toward the blister package (1) by means of the sealing film (13) of the blister package (1).

10. (Currently Amended) Blister package arrangement as in Claim 9, ~~characterized in that~~ wherein the conductor carrier strip (10) is at least partially provided with an electrically insulating protective layer (12) on its side facing away from the blister package (1) that covers at least the individual conductors (52) and ~~the~~ a common conductor (53).

11. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 8, characterized in that~~ Claim 1, wherein the conductor carrier strip (10') includes the individual conductors (52') on its side facing toward the blister package (1'), and that the side of the conductor carrier strip (10) facing toward the blister package (1') is provided with an electrically insulating layer (54') covering the individual conductors (52'), and ~~that~~ wherein the side of the electrically insulating layer (54') facing toward the blister package (1') is connected with the sealing film (13') of the blister package (1).

12. (Currently Amended) Blister package arrangement as in Claim 11, ~~characterized in that~~ wherein the electrically insulating layer (54') is provided with an adhesive layer

~~(66')~~ that may be connected with the sealing film ~~(13')~~ of the blister package ~~(1')~~, ~~or that the electrically insulating layer is simultaneously an adhesive layer that may be connected to the sealing film (13') of the blister package (1').~~

13. (Currently Amended) Blister package arrangement as in Claim 12, ~~characterized in that~~ wherein the adhesive layer ~~(66')~~ is covered by a tear film ~~(63')~~ that may be separated from the adhesive layer ~~(66')~~ in order to connect the adhesive layer ~~(66')~~ to the sealing film ~~(13')~~.

14. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 13, characterized in that~~ Claim 2, wherein the conductor carrier strip ~~(10')~~ projects over the blister package ~~(1)~~ at least on the side of the interface ~~(5)~~.

15. (Currently Amended) Blister package arrangement as in ~~one of Claims 1 through 14, characterized in that~~ Claim 1, wherein the conductor carrier strip ~~(10, 10')~~ forms the a first component of the carrier strip ~~(60)~~ that folds like a book, and whose a second component ~~(63)~~ is forms at least one of an insertion opening ~~(62)~~ for each pocket ~~(3, 3')~~ of



the blister package ~~(1, 1')~~ ~~or~~ and a common insertion opening ~~(62')~~ for all pockets ~~(3, 3')~~ of the blister package ~~(1, 1')~~, and may be folded about a fold line ~~(61)~~ with respect to the conductor carrier strip ~~(10, 10')~~ so that the blister package ~~(1, 1')~~ is accepted between the conductor carrier strip ~~(10, 10')~~ and the second part ~~(63)~~, whereby each pocket ~~(3, 3')~~ of the blister package ~~(1, 1')~~ extends through an insertion opening ~~(62)~~ of the second component ~~(63)~~ or all pockets ~~(3, 3')~~ of the blister package ~~(1, 1')~~ through the common insertion opening ~~(63')~~ of the second component ~~(63)~~, and ~~that~~ wherein the conductor carrier strip ~~(10, 10')~~, the blister package ~~(1, 1')~~, and the second component receiving the pockets ~~(3, 3')~~ of the blister package ~~(1, 1')~~ are connected with each other, ~~preferably~~ adhered.

16. (Currently Amended) Blister package arrangement as in Claim 15, ~~characterized in that~~ wherein the conductor carrier strip ~~(10, 10')~~ and the second component ~~(63)~~ project over the blister package ~~(1, 1')~~ at least on the side of ~~the~~ an interface ~~(5)~~ of the conductor carrier strip ~~(10, 10')~~ with a receiver device.

17. (Currently Amended) Blister package arrangement as in Claim ~~16~~ 15, ~~characterized in that~~ wherein the conductor carrier strip ~~(10, 10')~~ and the second component ~~(63)~~ project over the blister package ~~(1, 1')~~ on all sides.

18. (Currently Amended) Blister package arrangement as in ~~one of Claims 15 through 17, characterized in that~~ Claim 15, wherein the fold line ~~(61)~~ extends along the longer side of the conductor carrier strip ~~(10, 10')~~ and the second component ~~(63)~~.

19. (New) Blister package arrangement as in Claim 15, wherein the conductor carrier strip, the blister package and the second component receiving the pockets of the blister package are adhered together.

20. (New) Blister package as in Claim 11, wherein the electrically insulating layer is simultaneously an adhesive layer that may be connected to the sealing film of the blister package.



Please add the following Abstract of the Disclosure:

ABSTRACT OF THE DISCLOSURE

A blister package arrangement comprises a blister package (1) and a conductor carrier strip (10) attached thereto, wherein openings (4) of the carrier strip (10) are oriented toward pockets (3) of the blister package (1). When a tablet (2) is removed from a pocket (3), the sealing film (13) of the blister package (1) closing the pocket (3) is separated in such a way that the tablet (2) is removable through the opening (4) associated therewith. The openings (4) are formed by stamped cutting lines (41) which are disposed in the conductor carrier strip (10) and surround the pockets (3) of the associated areas in a ring shape. These stamped lines are interrupted by at least two spars (43) by means of which a cover (30), covering the pocket (3) and separated from the conductor carrier strip (10), is connected with the carrier strip. The spars (43) are distributed around the periphery of the stamped cutting lines (41) in such a way that at least one spar (43) is severed by pressure applied to the tablet (2) from the pocket (3). The conductor carrier strip (10) comprises, on the part thereof opposite to the blister package (1),

the part thereof opposite to the blister package (1),  
individual conductors (52), each of which extends from an  
individual connecting contact pad (51) to at least one spar  
(43) and is severed by a tablet removal.